# **BLM9D3740-16AM**

**LDMOS** 3-stage integrated Doherty MMIC

**AMPLEON** 

Rev. 1 — 21 December 2021

Product data sheet

# 1. Product profile

## 1.1 General description

The BLM9D3740-16AM is a 3-stage 16 W fully integrated Doherty MMIC solution using Ampleon's state of the art GEN9 LDMOS technology. The carrier and peaking device, input splitter and output combiner are integrated in a single package. This multiband device is perfectly suited as a device in the frequency range from 3700 MHz to 4000 MHz. Available in LGA outline.

#### Table 1. Performance

Typical RF performance at  $T_{case} = 25$  °C;  $I_{Dq} = 38$  mA (driver and final stages) in a demo circuit;  $V_{GSq(peaking)} = V_{GSq(carrier)} - 0.5$  V.

Test signal	f	V <sub>DS</sub>	P <sub>L(AV)</sub>	G <sub>p</sub>	η <sub>D</sub>	ACPR <sub>5M</sub>
	(MHz)	(V)	(W)	(dB)	(%)	(dBc)
single carrier W-CDMA [1]	3850	28	1.6	31.2	31.3	-34.8

[1] Test signal: 3GPP test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability on CCDF.

#### 1.2 Features and benefits

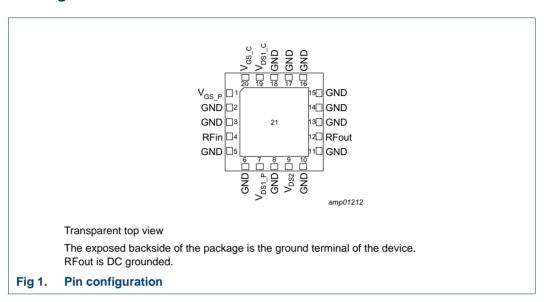
- Integrated input splitter
- Integrated output combiner
- Very high efficiency
- Designed for broadband operation (frequency 3700 MHz to 4000 MHz)
- Independent control of carrier and peaking bias
- Integrated ESD protection
- Excellent thermal stability
- High power gain, input and output matched to impedance 50  $\Omega$
- For RoHS compliance see the product details on the Ampleon website

## 1.3 Applications

RF power MMIC for multi-carrier and multi-standard GSM, W-CDMA, LTE and NR small cell base stations in the 3700 MHz to 4000 MHz frequency range

# 2. Pinning information

# 2.1 Pinning



# 2.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
V <sub>GS_P</sub>	1	gate-source voltage of peaking
GND	2	ground
GND	3	ground
RFin	4	RF input
GND	5	ground
GND	6	ground
V <sub>DS1_P</sub>	7	drain-source voltage of peaking driver
GND	8	ground
V <sub>DS2</sub>	9	drain-source voltage of final stages
GND	10	ground
GND	11	ground
RFout	12	RF output
GND	13	ground
GND	14	ground
GND	15	ground
GND	16	ground
GND	17	ground
GND	18	ground

Table 2. Pin description ...continued

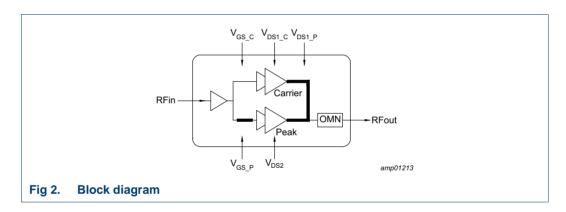
Symbol	Pin	Description
V <sub>DS1_C</sub>	19	drain-source voltage of carrier driver
V <sub>GS_C</sub>	20	gate-source voltage of carrier driver
GND	21	RF ground

# 3. Ordering information

Table 3. Ordering information

Type number	Package	Package		
	Name	Description	Version	
BLM9D3740-16AM		plastic thermal enhanced package; no leads; 20 terminals; body 7.0 x 7.0 x 0.98 mm	LGA-7x7-20-2	

# 4. Block diagram



# 5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DS}$	drain-source voltage		-	65	V
$V_{GS}$	gate-source voltage		-6	+11	V
T <sub>stg</sub>	storage temperature		-55	+125	°C
Tj	junction temperature	[1]	-	175	°C
T <sub>case</sub>	case temperature	[1]	-	125	°C

<sup>[1]</sup> Continuous use at maximum temperature will affect the reliability. For details refer to the online MTF calculator.

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# Thermal characteristics

#### Table 5. Thermal characteristics

Measured for total device.

Symbol	Parameter	Conditions	Value	Unit
R <sub>th(j-c)</sub>	thermal resistance from junction to	$T_{case} = 80  ^{\circ}C;  P_{L(AV)} = 1.6  W$ [1]	9.4	K/W
	case			

<sup>[1]</sup> When operated with a 1-carrier W-CDMA with PAR = 7.2 dB.

#### **Characteristics** 7.

#### Table 6. **DC** characteristics

 $T_{\rm case}$  = 25 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Carrier						
$V_{GSq}$	gate-source quiescent voltage	$V_{DS} = 28 \text{ V}; I_D = 38 \text{ mA}$	1.65	2.1	2.75	V
I <sub>GSS</sub>	gate leakage current	$V_{GS} = +11 \text{ V/}-5 \text{ V}; V_{DS} = 0 \text{ V}$	-	-	140	nA
Peaking	Peaking					
I <sub>GSS</sub>	gate leakage current	$V_{GS} = +11 \text{ V/}-5 \text{ V}; V_{DS} = 0 \text{ V}$	-	-	140	nA
Final sta	Final stages					
I <sub>DSS</sub>	drain leakage current	V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 60 V	-	-	1.4	μΑ
Driver st	Driver stages					
I <sub>DSS</sub>	drain leakage current	V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 60 V	-	-	1.4	μΑ

#### **RF** characteristics

Typical RF performance at  $T_{case} = 25$  °C;  $V_{DS} = 28$  V;  $I_{Dq} = 38$  mA (carrier);  $V_{GSq(peaking)} = V_{GSq(carrier)} - 0.5$  V;  $P_L = 1.6$  W; f = 4.0 GHz. Unless otherwise specified, measured in an Ampleon production circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Test signal: CW pulsed						
Gp	power gain		26	29	-	dB
$\eta_{D}$	drain efficiency		23	28	-	%
RLin	input return loss		-	-16	-8	dB
P <sub>L(3dB)</sub>	output power at 3 dB gain compression		40.0	41.5	-	dBm

# 8. Application information

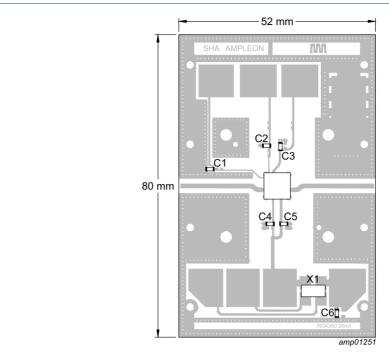
#### Table 8. Typical performance

Test signal: 1-carrier W-CDMA;  $T_{case} = 25 \, ^{\circ}\text{C}$ ;  $V_{DS} = 28 \, ^{\circ}\text{V}$ ;  $I_{Dq} = 38 \, \text{mA}$  (driver and final stages); test model 1; 64 DPCH;  $PAR = 7.2 \, \text{dB}$  at 0.01 % probability CCDF; unless otherwise specified, measured in an Ampleon 3700 MHz to 4000 MHz frequency band demo circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
P <sub>L(3dB)</sub>	output power at 3 dB gain compression	f = 3850 MHz	l -	42	-	dBm
$\eta_{D}$	drain efficiency	10 dB OBO (P <sub>L(AV)</sub> = 32 dBm); f = 3850 MHz	-	31.3	-	%
G <sub>p</sub>	power gain	P <sub>L(AV)</sub> = 32 dBm; f = 3850 MHz	-	31.2	-	dB
G <sub>flat</sub>	gain flatness	P <sub>L(AV)</sub> = 32 dBm; f = 3700 MHz to 4000 MHz	-	1.3	-	dB
ACPR <sub>5M</sub>	adjacent channel power ratio (5 MHz)	P <sub>L(AV)</sub> = 32 dBm; f = 3850 MHz	-	-34.8	-	dBc
ΔG/ΔT	gain variation with temperature	f = 3850 MHz	-	0.075	-	dB/°C
K	Rollett stability factor	$T_{case} = -40  ^{\circ}\text{C}$ ; f = 0.15 GHz to 5 GHz	<u>l</u> -	>1	-	

<sup>[1]</sup> Pulsed CW power sweep measurement ( $\delta$  = 10 %,  $t_p$  = 100  $\mu$ s).

<sup>[2]</sup> S-parameters measured in a demo circuit.



Printed-Circuit Board (PCB): Rogers 4350B;  $\epsilon_{\text{r}}$  = 3.66; thickness = 0.508 mm; thickness of copper plating = 35  $\mu$ m.

Fig 3. Component layout

Table 9. Demo test circuit list of components

See Figure 3 for component layout.

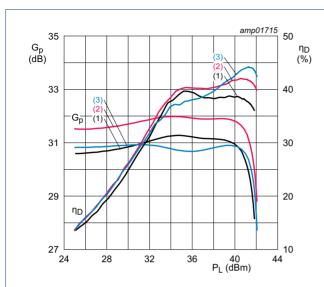
Component	Description	Value	Remarks
C1, C2, C3, C4, C5	multilayer ceramic chip capacitor	1 μF	1]
C6	multilayer ceramic chip capacitor	1 μF	1]
X1	current sense resistor	100 mΩ, 1 W	Y44870R10000B0R

<sup>[1]</sup> Murata or capacitor of same quality.

## 8.1 Ruggedness in a Doherty operation

The BLM9D3740-16AM is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions:  $V_{DS}$  = 28 V;  $I_{Dq}$  = 38 mA (carrier);  $V_{GSq(peaking)} = V_{GSq(carrier)} - 0.5$  V;  $P_i$  corresponding to  $P_L$  = 38.5 dBm under  $Z_S$  = 50  $\Omega$  load; f = 3700 MHz (CW);  $T_{case}$  = 25 °C.

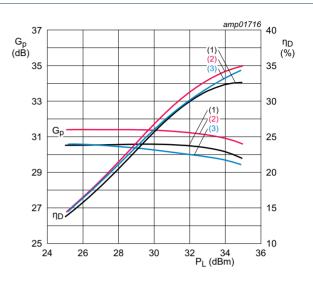
## 8.2 Graphs



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 38 mA;  $V_{GS(amp)peak}$  = 1.63 V;  $t_{D}$  = 100  $\mu s; \, \delta$  = 10 %.

- (1) f = 3700 MHz
- (2) f = 3850 MHz
- (3) f = 4000 MHz

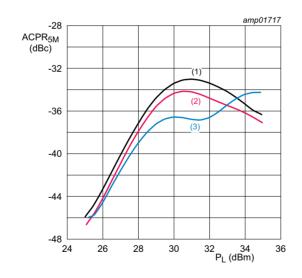
Fig 4. Power gain and drain efficiency as function of output power; typical values



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 38 mA;  $V_{GS(amp)peak}$  = 1.63 V Test signal: 1-carrier W-CDMA; 3GPP test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability on CCDF.

- (1) f = 3700 MHz
- (2) f = 3850 MHz
- (3) f = 4000 MHz

Fig 5. Power gain and drain efficiency as function of output power; typical values

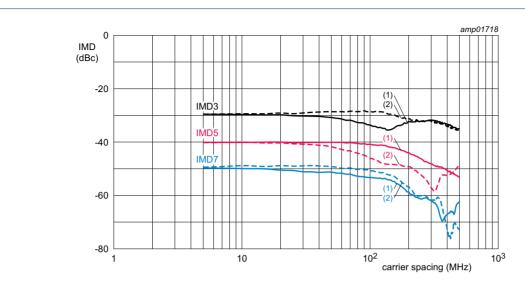


 $V_{DS} = 28 \text{ V}; I_{Dq} = 38 \text{ mA}; V_{GS(amp)peak} = 1.63 \text{ V}$ 

Test signal: 1-carrier W-CDMA; 3GPP test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability on CCDF.

- (1) f = 3700 MHz
- (2) f = 3850 MHz
- (3) f = 4000 MHz

Fig 6. Adjacent channel power ratio (5 MHz) as a function of output power; typical values



 $V_{DS}$  = 28 V;  $I_{Dq}$  = 38 mA;  $V_{GS(amp)peak}$  = 1.63 V; f = 3850 MHz.

Test signal: 2-carrier CW; P<sub>L</sub> at 1.6 W.

- (1) IMD low
- (2) IMD high

Fig 7. VBW capability

# 9. Package outline

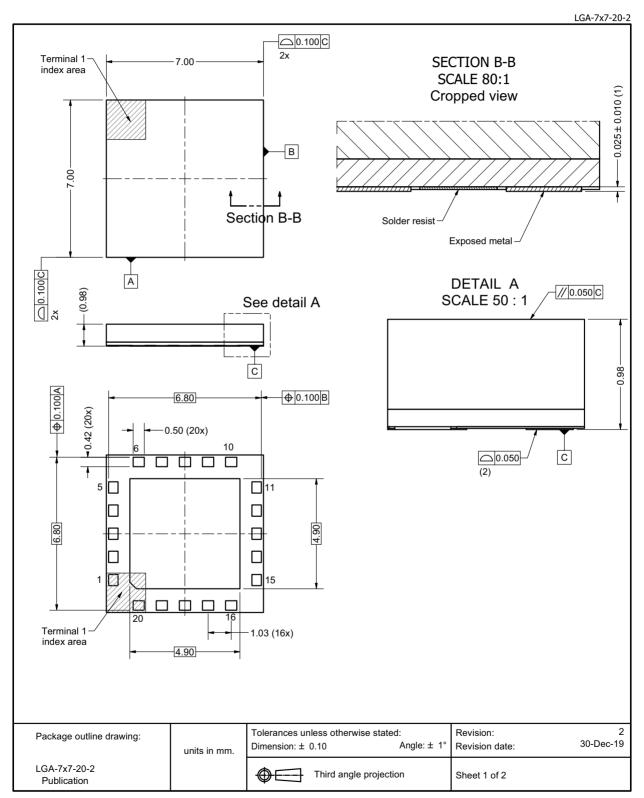


Fig 8. Package outline LGA-7x7-20-2 (sheet 1 of 2)

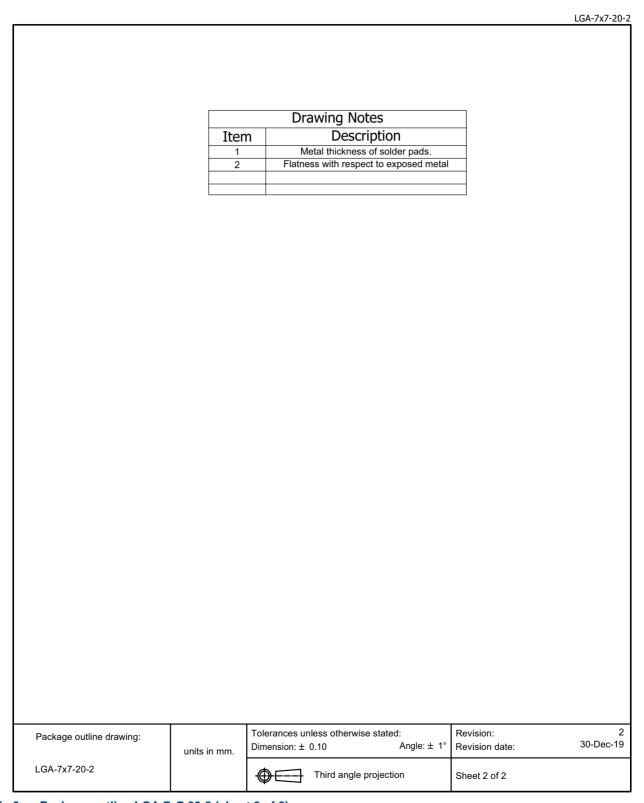


Fig 9. Package outline LGA-7x7-20-2 (sheet 2 of 2)

# 10. Handling information

#### **CAUTION**



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

Table 10. ESD sensitivity

ESD model	Class
Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002	C1 [1]
Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001	1B [2]

- [1] CDM classification C1 is granted to any part that passes after exposure to an ESD pulse of 250 V.
- [2] HBM classification 1B is granted to any part that passes after exposure to an ESD pulse of 500 V.

## 11. Abbreviations

Table 11. Abbreviations

Acronym	Description
3GPP	3rd Generation Partnership Project
CCDF	Complementary Cumulative Distribution Function
CW	Continuous Wave
DPCH	Dedicated Physical CHannel
ESD	ElectroStatic Discharge
GEN9	Ninth Generation
GSM	Global System for Mobile Communications
LDMOS	Laterally Diffused Metal Oxide Semiconductor
LTE	Long Term Evolution
MMIC	Monolithic Microwave Integrated Circuit
MTF	Median Time to Failure
NR	New Radio
ОВО	Output Back Off
PAR	Peak-to-Average Ratio
RoHS	Restriction of Hazardous Substances
VBW	Video Bandwidth
VSWR	Voltage Standing Wave Ratio
W-CDMA	Wideband Code Division Multiple Access

# 12. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLM9D3740-16AM v.1	20211221	Product data sheet	-	-

BLM9D3740-16AM

# 13. Legal information

#### 13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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